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(54) **SOLID ADHESIVE AGENT AND RAW MATERIAL COMPOSITION FOR THE SAME**

(57) The present invention relates to a solid adhesive agent with improved initial adhesion and a raw material liquid for preparing the solid adhesive agent. The solid adhesive agent of the present invention is obtainable by

blending an adhesive polymer with a glass transition temperature (T_g) of 40 to 55 °C and a gelling agent.

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